SHYAM SUNDAR D G











CAREER OBJECTIVE

I am a dedicated individual looking for a career in the reputed organization to secure a challenging position which utilizes my research and engineering skills that can contribute to the company's growth as well as enhance my knowledge by exploring the latest technology to grow professionally.

PROFESSIONAL EXPERIENCE

Senior Software Engineer

(July 2023 - Present)

Mirafra Technology Private Limited

Bangalore

Currently working as a Senior Software Engineer for the position of Embedded Software at Mirafra Technology Private Limited

Research Associate-I

(Feb 2021 - June 2023)

Department of Electronic Systems Engineering,

Indian Institute of Science, Bangalore

1. Project Title: Wi-Fi Modeling and Video Casting (Feb 2021- Jan 2023)

Worked on Wireless Local Area Network (WLAN) modeling of IEEE 802.11n/ac/ax for indoor and outdoor applications, which is a part of **IISc-Aerospace Network Research Consortium (ANRC)**, along with Boeing Research Labs. More details in the link

The project supervisors were Neelesh B Mehta and Chandramani Singh.

- Evaluated the PHY layer performance by simulating SNR vs PER for different channel models, spatial streams, and bandwidth for 802.11n and 802.11ac
- Investigated different rate control algorithms (Ideal, DRCA, ARF, and Minstrel-HT), where their performance were evaluated in a dynamic channel conditions
- Minstrel-HT rate control algorithm code was written and integrated in MATLAB-WLAN Toolbox, which was also calibrated and validated referring to NS3 rate control algorithm and Linux driver (ath10k is the mac80211 wireless driver) for 802.11n and 802.11ac
- Performed a System-level simulation of 802.11n to examine the interference of multiple Wi-Fi Networks on the same channel inside an aircraft scenario, by analysing the throughput and packet loss when RTS/CTS, packet aggregation, Block Acknowledgement are enabled with and without Rate adaptation
- Worked on 802.11ax OFDMA scheduler and its optimisation using weighted round robin scheduler

2. Project Title: Cyber security of IED devices used in Power Grid Applications (Feb 2023 - June 2023)

Currently working on a project to build security analysis tools for evaluating Intelligent Electronic Devices (IEDs) for possible hardware or software vulnerabilities which are used in Power grid, the project is part of the **Power Grid Corporation of India Limited (PGCIL)**.

The project supervisors are Chandramani Singh and Haresh Dagale

- Reverse Engineering and blackbox testing of the IEDs are used to extract and analyse the binary image by using Binary Image Analysis tools like Ghidra, and Binwalk.
- Performed IEC61850 protocol communication using IEDexplorer simulator

3. Project Title: Tactile Cyber-Physical Systems

Worked on Edge Intelligence part of the project, which is a part of the **Ministry of Electronics & Information Technology (MEITY)**. The project supervisors were T V Prabhakar and Chandramani Singh.

 Developed a Tactile Force Sensor Array which is interfaced with Robotiq 2F-85 two finger gripper. The force data is collected using ATmega2560, and is sent back to the haptic device which is remotely operated. This data is used to <u>intelligently grip</u> a tool by using edge intelligence algorithms.

4. Project Title: Bluetooth Low Energy (BLE) based sensor monitoring system for pharmaceutical products.

- Responsible for leading a team in Research and Development of the complete project.
- Designed the custom Rigid and Flexible PCBs for microcontrollers.
- Developed a final product to be compact, with efficient power usage making it fit for the commercial market.

Electronics Design Engineer

(Sep 2019 - Dec 2020)

Axxonet System Technologies Pvt.Ltd, Bangalore.

Major contribution to the development of multiple medical devices related to Neuroscience in accordance to medical device regulation

- Hands-on experience in interfacing multiple peripherals to an Embedded system like ADC, PMIC, and Battery Management ICs.
- Utilized Altium Designer to its full potential, showcasing proficiency in schematic capture and PCB layout design, ensuring precision and functionality.

Employee Internship

(July 2019 – Aug 2019)

Axxonet System Technologies Pvt.Ltd, Bangalore.

- Research and Development for the best Instrumentation Amplifier IC having higher Bandwidth.
- Switching Power Supply between an Internal and External Battery without interrupting the operation of the system.

Summer Internship (4 weeks)

SIENNA ECAD Technologies Private Ltd, Bangalore.

• Electronic Design Automation with focus on Printed Wiring/Circuit Board Engineering.

B.E. in Electronics and Communication Engineering, RNSIT, Bangalore. (2015 - 2019)

Final year Project: Internet of Things(IoT) based Smart Healthcare Kit

- The Firmware code was Implemented in Python for Cortex-A53 64-bit SoC (Raspberry-pi).
 Interfaced with sensors using wired communication protocols (SPI,I2C, single wire/bus).
 Sensor read values were processed and transmitted using 2.4GHz WiFi.
- The ThingSpeak cloud IoT platform was used for data storage and remote viewing using mobile applications. Alert text messages/sms are sent to specific mobile phone numbers.

TECHNICAL SKILLS

Programming Language: C, Python and MATLAB

WiFi Technology: IEEE 802.11n, 802.11ac, and 802.11ax

Link Simulator: MATLAB communication/WLAN Toolbox

Network Simulator: ns-3

PHY/MAC: Rate control algorithms, CSMA-CA

Hardware: ABB REL670 Intelligent Electronic Device(IED), ESP32, ESP8266 Wi-Fi SoC, ATMEGA 328p (Arduino-UNO), Cortex-A53 64-bit SoC (Raspberry-pi), MSP430.

Software Tools: MATLAB, Simulink, Wireshark, OpenWRT, Or-CAD Capture, Eagle, Altium Circuit Studio.

ADDITIONAL INFORMATION

- Active volunteer and committee member for Indian Institute of Science,
 Open Day-2023, DESE
- Awarded, The Best Hardware Project for demonstrating <u>Laser Communication System</u> at the college level Open House Project Expo-2018
- Awarded, The Best Hybrid/Embedded Project for demonstrating <u>Prosthetic Robotic Arm</u> with Gesture Control Instructions at the college level Open House Project Expo-2017
- Awarded, The Best Hybrid/Embedded Project for demonstrating <u>Smart Home Automation</u>
 <u>System</u> at the college level Open House Project Expo-2017